



Dell PowerEdge rack servers help you build a modern infrastructure that minimizes IT challenges and drives business success. Our Quick Reference Guide (QRG) includes a condensed view of our entire rack server portfolio.

Rack Server	R770	R670	R470			
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Key attributes	Open ecosystem optimized for compute workloads and provides maximum performance with optimized power for virtualization and microservices, cloud-native applications, and largescale analytics.	Open ecosystem optimized for compute workloads and designed to optimize power and balance performance for high-density deployments, cloud-native applications, and all-flash SDS.	Purpose-built to maximize efficiency and affordability with optimized single-socket servers, delivering power-packed performance for cloud scale web and app microservices, data services, virtualization, and scale-out database.			
Target workloads	Max virtualization, Hyper-converged and Cloud-Native, Big Data and Analytics, Software-Defined Storage, Efficient GPU support	High density virtualization and Cloud-Native, Scale-Out Database, Software-Defined Storage, Efficient GPU support	Virtualization / Cloud Scale, Scale-Out Database, Edge Compute, High Performance Compute, Software-Defined Storage Node			
Type of processor	2 x Intel Xeon 6 Processors; processor	up to 144 cores per	1 x Intel Xeon 6 Processors; up to 144 cores per processor			
DDR5 DIMM slots (max capacity)	32 (2 TB)		16 (1 TB)			
Disk drives up to:	8 x E3.S, 16 x E3.S 8 x 2.5" NVMe 16 x 2.5"	8 x E3.S 8 x 2.5"	8 x 2.5", 8 x E3.S			
NVMe drives up to:	16	8	8			
Gen5 PCIe slots up to:	4	2	2			
Gen4 PCIe slots up to:	NA	NA	NA			
Accelerator support up to:	4 x 75 W SW	2 x 75 W SW	2 x 75 W SW			
Rack height (U)	2	1	1			
Integrated security	Cryptographically signed firm Encryption (SEDs with local Secure Boot, Secured Comp integrity check), Silicon Root System Lockdown (requires Datacenter), TPM 2.0 FIPS,	TPM 2.0 FIPS, Cryptographically Signed Firmware, Secure Boot being standard security, Silicon Root of Trust on all racks				

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Rack Server	R760	R660	R7625	R6625	R7615	R6615	R660xs	R760xs	HS5610***	HS5620***	
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Key attributes	Provides performance and versatility for demanding applications	Provides performance and versatility for demanding applications	Breakthrough performance	Breakthrough performance	Powerful performance and scalability	Peak performance and excellent TCO	Right-sized for the most popular IT applications	Right-sized for the most popular IT applications	Open ecosystem optimized for compute workloads	Open ecosystem optimized for storage dense workloads	
Target workloads	Mixed Workload Standardization Database and Analytics Virtual Desktop Infrastructure	High Density Virtualization, Dense Database Analytics, Mixed Workload Standardization	High Performance Computing (HPC), Virtual Desktop Infrastructure (VDI), Virtualization	High Performance Computing (HPC), Virtual Desktop Infrastructure (VDI), Virtualization	Software-Defined Storage (SDS), Virtualization, Data Analytics	Virtualization, Hyper-Converged Infrastructure (HCI), Network Functions Virtualization (NFV)	Virtualization, Cloud, Scale- Out Database, High Performance Compute (HPC)	Virtualization, Software-Defined Storage, Medium density VM or VDI	Virtualization, Scale-out database, Software- Defined Storage Node	Virtualization, Medium VM Density or VDI, Software- Defined Storage Node	
Type of processor	2 x 4th Generation Intel® Xoup to 56 cores per processor 2 x 5th Generation Intel® Xoup to 64 cores per processor	or or eon® Scalable processors;	2 x AMD EPYC [™] 4th Gene up to 128 cores per process	· ·	1 x AMD EPYC [™] 4th General up to 128 cores	ration 9004 series processor;	2 x 5th generation Intel® Xe with up to 28 cores or 2 x 4th Generation Intel Xec up to 32 cores per processor	on Scalable processors with	2 x 5th generation Intel® Xeon® Scalable processors with up to 32 cores or 2 x 4th Generation Intel Xeon Scalable processors with up to 32 cores per processor		
DDR5 DIMM slots (max capacity)	32 (8 TB)		24 (6 TB)		12 (3 TB)	12 (3 TB)		16 (1.5 TB)	16 (2 TB)	16 (2 TB)	
Disk drives up to:	12 x 3.5" 8 x 2.5" 16 x 2.5" 24 x 2.5" 16 x E3.S 2 x 2.5" (rear) 4 x 2.5" (rear) 4 x E3.S (rear)	8 x 2.5" 10 x 2.5" 2 x 2.5" (rear) 10 x 2.5" 14 x E3.S 16 x E3.S 2 x 2.5" (rear) 2 x E3.S (rear)	8 x 3.5" 12 x 3.5" 8 x 2.5" 16 x 2.5" 24 x 2.5" 2 x 2.5" (rear) 4 x 2.5" (rear) 4 x E3.S (rear)	4 x 3.5" 8 x 2.5" 10 x 2.5" 14 x E3.S 16 x E3.S 2 x 2.5" (rear) 2 x E3.S (rear)	8 x 3.5" 12 x 3.5" 8 x 2.5" 16 x 2.5" 24 x 2.5" 2 x 2.5" (rear) 4 x 2.5" (rear) 4 x E3.S (rear)	4 x 3.5" 8 x 2.5" 10 x 2.5" 14 x E3.S 16 x E3.S 2 x 2.5" (rear) 2 x E3.S (rear)	4 x 3.5" 8 x 2.5" 10 x 2.5" 2 x 2.5" (rear)	12 x 3.5" 8 x 3.5" 8 x 2.5" 16 x 2.5" + 8 x NVMe 2 x 2.5" (rear)	4 x 3.5" 8 x 2.5" 6 x NVMe 10 x 2.5" 2 x 2.5" (rear)	12 x 3.5" 8 x 3.5" 8 x 2.5" 16 x 2.5" + 8 x NVMe 2 x 2.5" (rear)	
NVMe drives up to:	24	10	24	10	24	10	10	8	10	8	
Gen5 PCIe slots up to:	4	2	4	2	4	2	2	2	2	2	
Gen4 PCIe slots up to:	8	3	8	3	4	3	3	4	3	4	
Accelerator support up to:	2 x 350 W DW or 6 x 75 W SW	3 x 75 W SW	2 x 300 W DW or 6 x 75 W SW	3 x 75 W SW	3 x 300 W DW or 6 x 75 W SW	3 x 75 W SW	N/A	2 x 75 W SW	N/A	2 x 75 W SW	
Rack height (U)	2	1	2	1	2	1	1	2	1	2	
Integrated security	Firmware, Chassis Intrusion of Trust, System Lockdown Encryption (SEDs with local	iffied, TPM 2.0 China NationZ Alert, Secure Boot being star (requires iDRAC9 Enterprise or external key mgmt) Securand System Erase on all racks	ndard security, Silicon Root or Datacenter), Data at Rest ed Component Verification	Firmware, Secure Boot, Sec	tified, TPM 2.0 China NationZ cure Erase, Silicon Root of True e or Datacenter), AMD Secure Virtualization (SEV)	ıst, System Lockdown	Alert, Secure Boot being standard security, Silicon Root of Trust, System Lockdown (requires iDRAC9 Enterprise				

^{***} HS560 and HS5620 are offered exclusively through the Hyperscale Next program for select customers





Rack Server	R960	R860	R760xa	R760xd2	XE9680	XE9640	XE8640	XR7620	XR5610	R360	R260
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Key attributes	Extreme acceleration for business critical, core continuity and scale out high-density compute		ss critical, core scalable server and workloads with for intensive GPU high-density applications		No-compromise accelerated AI training performance, Flexibility to choose H100 or A100 8-way SXM GPUs, 6U 2-socket with support up to 35C ambient		Faster ML/DL training and HPC performance, 4U 2-socket server, up to 35C ambient, standard rack depth	Edge-optimized high- performance, high-capacity short-depth 2U 2-socket server	High-performance, short depth, rugged, reverse mounting, filtered bezel, -5C to 55C operating temperatures	Streamlined productivity, high- enterprise GPU, and powerful compute to address common business applications.	Short-depth rack server with filter beze for Near-Edge customers featuring the latest Intel Xeon-E 2400 series processors, DDR5 memory, NVMe BOSS, and Energy Star 4.0 PSU
Target workloads	Large in-memory databases, Data analytics, AI and virtualization, Virtual Desktop Infrastructure (VDI)		,		Large model training, natural language processing, recommendation engines, conversational AI, translation, drug discovery	HPC Modeling and Simulation, seismic analysis, computational fluid dynamics, Oil & Gas, Al/ML training, object detection, image classification	HPC Modeling and Simulation, seismic analysis, computational fluid dynamics, Oil & Gas, AI/ML training, object detection, image classification	Industrial automation, video analytics, point of sale analytics, Al inferencing, edge asset data aggregation and analytics	vRAN, D-RAN, O-RAN, wIndustrial automation, video analytics, point of sale analytics, Al inferencing, edge asset data aggregation and analytics	Collaboration and Sharing, Mail and Messaging, Database	Collaboration and Sharing, Mail and Messaging, Near-Edge Applications
Type of processor	4 x 4th Generation Intel® Xeon® Scalable processors; up to 60 cores per processor and with optional Intel® QuickAssist Technology		60 cores per processor		2 x 4th Generation Intel® Xeon® Scalable processors; up to 56 cores per processor or 2 x 4th Generation Intel® Xeon® Scalable processors; up to 56 cores per processor	2 x 4th Generation Intel® Xeon® Scalable processors; up to 56 cores per processor	2 x 5th Generation Intel® Xeon® Scalable processors; up to 64 cores per processor	2 x 5th Generation Intel® Xeon® Scalable processors; up to 16 cores per processor or 2 x 4th Generation Intel® Xeon® Scalable processors; up to 32 cores per processor	1 x 5th Generation Intel® Xeon® Scalable processors; up to 16 cores per processor or 1 x 4th Generation Intel® Xeon® Scalable processors; up to 32 cores per processor	1 x Intel Xeon E-2400 series processor with up to 8 cores or 1 x Intel Pentium processor with 2 cores	1 x Intel Xeon E-2400 series processor with up to 8 cores or 1 x Intel Pentium processor with 2 cores
DDR5 DIMM slots (max capacity)	64 (16 TB)		32 (8 TB)	16 (1.5TB)	32 (4 TB)	• 16 (1 TB) Intel GPU • 8, 16, 32 (2 TB) NVIDIA GPU	32 (4 TB)	16 (1 TB)	8 (1 TB)	4 (128 GB)	4 (128 GB)
Disk drives up to:	8 x 2.5" 8 x 2.5" 16 x 2.5" 16 x 2.5" 24 x 2.5" 24 x 2.5" 32 x 2.5" 8 x E3.S 16 x E3.S 2 x 2.5" (rear) 8 x 2.5" + 16 x E3.S		16 x 2.5" 8 x 2.5" 3.5" (24 x 2.5" 6 x E3.S 2 x 2. 8 x E3.S 0r 4 x 2 x 2.5" (rear)		8 x 2.5" 16 x E3.S	4 x 2.5"	8 x 2.5"	4 x 2.5" 8 x E3.S	4 x 2.5"	4 x 3.5" 8 x 2.5"	2 x 3.5" 6 x 2.5"
NVMe drives up to:	24	24	8	4	8	4	8	4	4	N/A	N/A
Gen5 PCIe slots up to:	12	8	12	N/A	10	4	4	2	2	N/A	N/A
Gen4 PCIe slots up to:	N/A	4	N/A	5	N/A	N/A	N/A	5	N/A	2	2
Accelerator support up to:	4 x 400 W DW N/A		4 x 400 W DW or 12 x 75 W SW	2 x 75 W SW , 1 x 75 W SW + 1 x 150 W SW or 1 x 180 W DW	8 NVIDIA HGX H100 80 GB 700 W SXM5 GPUs or 8 NVIDIA HGX A100 80 GB 500 W SXM4 GPUs or 8 AMD Instinct MI300X 192GB 750W OAM GPU or 8 Intel Gaudi3 128GB 900W OAM GPU		4 NVIDIA HGX H100 80 GB 700 W SXM5 GPUs, fully interconnected with NVIDIA NVLink technology	4 x 150 W SW or 2 x 300 W DW	2 x 75 W SW	1 x 60 W SW	N/A
Rack height (U)	4	2	2	2	6	2	4	2	1	1	1
Integrated security	TPM 2.0 FIPS, CC-TC (Hardware integrity ch			ically Signed Firmware, Chassis	Intrusion Alert, Secure Boot being st	andard security, Silicon Root of	of Trust, System Lockdown (red	quires iDRAC9 Enterprise or Data	center), Data at Rest Encryption	(SEDs with local or external key mg	mt) Secured Component Verification

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Rack Server	R750	R750xa	R650	R7525	R6525	R7515	R6515	R750xs	R650xs	R450	R550	XR11	XR12	R350	R250
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Key attributes	Outstanding performance for the most demanding workloads	Highly intensive GPU workloads	High scalability, optimized workload performance	Powerful performance and flexibility	Dense virtualization	Powerful performance and scalability	High density compute	Purpose-built 2U server for growing scale- out solutions	Purpose-built, full performance 1U server for dense, fast growing scale- out solutions	Value and density- focused, built for general purpose IT	Versatile, value-optimized, virtualization- ready, built for general purpose IT	Edge-centric, short depth and rugged with reverse mounting options	Edge-centric, short depth and rugged with reverse mounting options	Powerful performance in 1U server for productivity and data intensive applications	Powerful compute for common business applications and streamlines productivity
Target workloads	Database and analytics, HPC, traditional corporate IT, VDI, AI, or ML environments	Al, ML or DL training or inferencing, HPC, and vitualization environments	Mixed workload standardization, database and analytics, HFT, traditional corporate IT, VDI, HPC, AI, or ML environments	All flash SDS, VDI, and data analytics	HPC, Dense VDI, and Virtualization	SDS, Virtualization, and Data Analytics	Virtualization, HCI and NFV	Virtualization, medium VM density or VDI, and scale- out database workloads	Virtualization, cloud, scale-out database and highperformance compute workloads	Small IT infrastructure, light VM, small business specific workloads	Small IT infrastructure, light VM density, small business specific workloads	Telco/5G (MEC, CDN, vRAN), Military, Retail (Analytics - video surveillance/ POS/IOT aggregation)	Telco/5G (MEC, CDN, vRAN), Military, Retail (Analytics - video surveillance/POS/ IOT aggregation)	Small mid-sized businesses, remote office/branch office, collaboration and sharing, data analytics and virtualization workloads	Small mid-sized businesses, remote office/branch office, collaboration and sharing, mail/messaging and file/print workloads
Type of processor	2 x 3 rd Generation Intel® Xeon® Scalable processors; up to 40 cores per processor			EPYC™ processors; up to EPY		1 x 2 nd or 3 rd Generation AMD EPYC TM processor; up to 64 cores per processor		2 x 3 rd Generation Intel® Xeon® Scalable processors; up to 32 cores per processor		2 x 3 rd Generation Intel® Xeon® Scalable processors; up to 24 cores per processor		1 x 3 rd Generation Intel® Xeon® Scalable processors; up to 36 cores per processor		1 x Intel Xeon E-2300 series processors with up to 8 cores or 1 x Intel Pentium processor with up to 2 cores	
DDR4 DIMM slots (max capacity)	32 (8 TB)		32 (4 TB)			16 (2 TB)		16 (1 TB)				8 (1 TB)		4 (128 GB)	
Disk drives up to:	12 x 3.5" 8 x 2.5" 16 x 2.5" 24 x 2.5" 2 x 2.5" or 4 x 2.5" (rear)	6 x 2.5" 8 x 2.5"	4 x 3.5" 8 x 2.5" 10 x 2.5" 2 x 2.5" (rear)	12 x 3.5" 26 x 2.5"	4 x 3.5" 12 x 2.5"	12 x 3.5" 24 x 2.5"	4 x 3.5" 8 x 2.5"	8 x 3.5" 12 x 3.5" 8 x 2.5" 16 x 2.5 + 8 x 2.5"	4 x 3.5" 8 x 2.5" 10 x 2.5" 2 x 2.5" (rear)	4 x 3.5" 8 x 2.5"	8 x 3.5" 8 x 2.5" 16 x 2.5"	4 x 2.5"	6 x 2.5"	4 x 3.5" 8 x 2.5"	4 x 3.5" (cabled) 2 x 3.5" (cabled)
NVMe drives up to:	24	8	12	24	12	24	10	8	10		N/A	4	6		N/A
Gen4 PCIe slots up to:	8	8	3	8	3	2	1	5	3	2	3	3	5	3	2
Gen3 PCIe slots up to:	N/A				2	1	1	1 N/A 1					N/A		
Accelerator support up to:	2 x 300 W DW or 4 x 150 W SW or 6 x 75 W SW	4 x 150 W SW or 4 x 300 W DW 2 x 75 W SW	3 x 75 W SW	3 x 300 W DW or 6 x 75 W SW	3 x SW	4 x SW; 1 x DW; 1 x FPGA	1 x SW	N/A			2 x 75 W SW	2 x 75 W or 150 W SW 2 x 300 W DW		N/A	
Rack height (U)	2	2	1	2	1	2	1	2	1	1	2	1	2	1	1
Integrated security	TPM 1.2/2.0 FIPS, or Datacenter), and			ationZ, Cryptograp	phically Signed Firm	mware, Chassis Int	rusion Alert, and Se	ecure Boot being s	tandard security on	all racks. Integrat	ed security feature	s such as Silicon F	Root of Trust, System L	ockdown (requires iDRA	C9 Enterprise





Rack Server	R940	R940xa	R840	R740xd	R740	R740xd2	R640	R540	R440	R340	R240
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Key attributes	Powerful performance	Extreme acceleration	Turbocharge data analytics	Scalable storage performance	Optimal application performance	Enterprise content server	Performance and density	Balanced and adaptable	Scale-out computing	Accelerate business growth	Compute made simple
Target workloads	In-memory databases	GPU database acceleration and machine learning	Data-intensive workloads, HFT, and dense virtualization	SDS, service providers, and big data servers	VDI and cloud workloads	Media streaming and SDS	Dense scale-out data center computing and storage	Mail messaging and virtualization	HPC, web tech, and scale-out infrastructure	ROBO productivity and data-intensive applications	Small business and service provider workloads
Type of processor	4 x 2 nd Generation Intel [®]	Xeon® Scalable processors		2 x 2 nd Generation Intel®	Xeon® Scalable processo	rs				1 x Intel Xeon E-2200, Intel Core i3®, Intel Pentium®, or Intel Celeron® processor	
DDR4 DIMM slots (max capacity)	48 (15.36 TB)			24 (7.68 TB)		16 (1 TB)	24 (7.68 TB)	16 (1 TB)		4 (64 GB)	
Disk drives up to:	24 x 2.5"	32 x 2.5"	26 x 2.5"	18 x 3.5" 32 x 2.5"	8 x 3.5" 16 x 2.5"	26 x 3.5" 16 x 3.5" + 10 x 2.5" ²	4 x 3.5" 12 x 2.5"	14 x 3.5"	4 x 3.5" 10 x 2.5"	4 x 3.5" 8 x 2.5"	4 x 3.5" 4 x 2.5" ²
NVMe drives up to:	12	4	24			N/A	10	N/A	4	N/A	
Gen4 PCIe slots up to:						N/A					
Gen3 PCle slots up to:	13	12	6	8		5	3	5	2	2	
Accelerator support up to:	N/A	4 x DW GPUs or 4 x DW or 8 x SW FPGAs	2 x DW GPUs or 2 x SW or DW FPGAs	3 x DW or 6 x SW GPUs or 3 x DW or 4 x SW FPGAs		N/A	1 x SW GPU or 1 x SW FPGA		١	N/A	
Rack height (U)	3	4	2				1	2	1	1	
Integrated security	TPM 1.2/2.0 FIPS, CC-7 Datacenter), and System	CG certified, TPM 2.0 China n Erase on all racks	a NationZ, Cryptographical	ly Signed Firmware, Chas	sis Intrusion Alert, and Se	cure Boot being standard s	ecurity on all racks. Integra	ted security features such a	s Silicon Root of Trust, Sys	stem Lockdown (requires	iDRAC9 Enterprise or

¹ Not all features are available on all platforms.

² Drives use hybrid carrier to fit in 3.5" drive bay. (For the R740xd2 - a hybrid configuration is available with up to 10 2.5" SSDs)

Cyber Resilient Architecture for Zero Trust IT environment & opoperations

Security is integrated into every phase of the PowerEdge lifecycle, including protected supply chain and factory-to-site integrity assurance. The Silicon-based root of trust anchors end-to-end boot resilience while Multi-Factor Authentication (MFA) and role-based access controls safeguard trusted operations.

Sustainability

From recycled materials in our products and packaging, to thoughtful, innovative options for energy efficiency, the PowerEdge portfolio is designed to make, deliver, and recycle products to help reduce the carbon footprint and lower your operation costs. We even make it easy to retire legacy systems responsibly with Dell Technologies.

Increase efficiency and accelerate operations with an autonomous infrastructure

The Dell OpenManage systems management portfolio tames the complexity of managing and securing IT infrastructure. Using Dell Technologies' intuitive end-to-end tools, IT can deliver a secure, integrated experience by reducing process and information silos in order to focus on growing the business. The Dell OpenManage portfolio is the key to your innovation engine, unlocking the tools and automation that help you scale, manage, and protect your technology environment.

Rest easier with Dell Technologies Services

Maximize your PowerEdge Servers with comprehensive services designed to meet you wherever you are. Accelerate time to value in achieving high AI use cases with Professional Services for AI, choose from tailored deployment options with the ProDeploy Suite, receive proactive and predictive support with our ProSupport Suite, and so much more with our services available across 170 locations and backed by our 60K+ employees and partners.

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